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PPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO
09/944,983	08/30/2001	Paul A. Farrar	1303.018US1	1908
21186 7	590 07/15/2004		EXAMINER	
	N, LUNDBERG, WOE	RACHUBA, MAURINA T		
P.O. BOX 293 MINNEAPOL	8 IS, MN 55402		ART UNIT	PAPER NUMBER
			3723	

DATE MAILED: 07/15/2004

Please find below and/or attached an Office communication concerning this application or proceeding.

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	Application No.	Applicant(s)	- oh
Advisory Action	09/944,983	FARRAR, PAUL A.	/
navioury nearli	Examiner	Art Unit	
	M Rachuba	3723	,
The MAILING DATE of this communication a	ppears on the cover sheet v	vith the correspondence addre	ss
THE REPLY FILED 10 June 2004 FAILS TO PLACE Therefore, further action by the applicant is required to final rejection under 37 CFR 1.113 may only be either condition for allowance; (2) a timely filed Notice of App Examination (RCE) in compliance with 37 CFR 1.114.	o avoid abandonment of thi : (1) a timely filed amendmo peal (with appeal fee); or (3	is application. A proper reply tent which places the application	to a on in
PERIOD FOR	REPLY [check either a) or	b)]	
a) The period for reply expiresmonths from the mail to b) The period for reply expires on: (1) the mailing date of the no event, however, will the statutory period for reply exponents of the statutory period for the statutory period for the statutory period for the statutory period for the statutory of the statutory	his Advisory Action, or (2) the dath bire later than SIX MONTHS from WAS FILED WITHIN TWO MONT The date on which the petition un and of extension and the correspond of the shortened statutory period Office later than three months aft	the mailing date of the final rejection. THS OF THE FINAL REJECTION. Solder 37 CFR 1.136(a) and the approprinting amount of the fee. The approprint for reply originally set in the final Of	. ee MPEP riate extension riate extension fice action; or
1. A Notice of Appeal was filed on Appella	nt's Brief must be filed with	in the period set forth in	

37 CFR 1.192(a), or any extension thereof (37 CFR 1.191(d)), to avoid dismissal of the appeal. 2. The proposed amendment(s) will not be entered because: (b) they raise the issue of new matter (see Note below); (c) X they are not deemed to place the application in better form for appeal by materially reducing or simplifying the issues for appeal; and/or (d) \times they present additional claims without canceling a corresponding number of finally rejected claims. NOTE: See Continuation Sheet. 3. Applicant's reply has overcome the following rejection(s): 4. Newly proposed or amended claim(s) _____ would be allowable if submitted in a separate, timely filed amendment canceling the non-allowable claim(s). 5. The a) affidavit, b) exhibit, or c) request for reconsideration has been considered but does NOT place the application in condition for allowance because: 6. The affidavit or exhibit will NOT be considered because it is not directed SOLELY to issues which were newly raised by the Examiner in the final rejection. 7. For purposes of Appeal, the proposed amendment(s) a) will not be entered or b) will be entered and an explanation of how the new or amended claims would be rejected is provided below or appended. The status of the claim(s) is (or will be) as follows: Claim(s) allowed: _____. Claim(s) objected to: Claim(s) rejected: 1,2,4-16,18-21,24-27,29-36,38,39,41-57,59-66,69-75,77-80,82-88 and 90-92. Claim(s) withdrawn from consideration: 3 17 28 37 40 58 67 68 76 81 89. 8. The drawing correction filed on is a) approved or b) disapproved by the Examiner. 9. Note the attached Information Disclosure Statement(s)(PTO-1449) Paper No(s). 10. Other: ____ M Rachuba **Primary Examiner**

Art Unit: 3723

Continuation of 2. NOTE: the proposed limitations ", wherein the length of the polishing pad drum spans across the wafer to polish the wafer in one pass" is a new issue, requiring further consideration and/or search.

Applicant argues that he is unable to find reference to a rigid polishing pad in the disclosure of '666. Please refer to column 2, lines 19-33 and column 4, lines 1-5. "Roget's Thesaurus of English Words and Phrases" lists the following: Matter: Inorganic matter: Hardness rigid (adjective). The examiner considers that hardness is equivalent to rigidness, lacking further definition. Applicant has not disclosed any parameters or definitions that would not allow the examiner to interpret the term "rigid" as "hard".